

# SN54ABT620, SN74ABT620 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS113D – FEBRUARY 1991 – REVISED APRIL 1998

- State-of-the-Art *EPIC-II<sup>B</sup>*™ BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- Typical  $V_{OLP}$  (Output Ground Bounce) < 1 V at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$
- High-Drive Outputs (–32-mA  $I_{OH}$ , 64-mA  $I_{OL}$ )
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK), and Plastic (N) and Ceramic (J) DIPs

## description

These octal bus transceivers provide for asynchronous communication between data buses. The control-function implementation allows for maximum flexibility in timing. The 'ABT620 devices provide inverted data at the outputs.

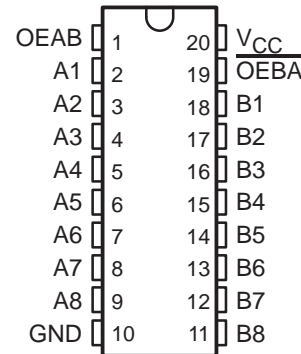
These devices allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic levels at the output-enable (OEAB and  $\overline{\text{OEBA}}$ ) inputs.

The output-enable inputs can be used to disable the device so that the buses are effectively isolated. The dual-enable configuration gives the transceivers the capability of storing data by simultaneously enabling OEAB and  $\overline{\text{OEBA}}$ . When both OEAB and  $\overline{\text{OEBA}}$  are enabled and all other data sources to the two sets of bus lines are at high impedance, both sets of bus lines (16 total) remain at their last states. In this way, each output reinforces its input in this configuration.

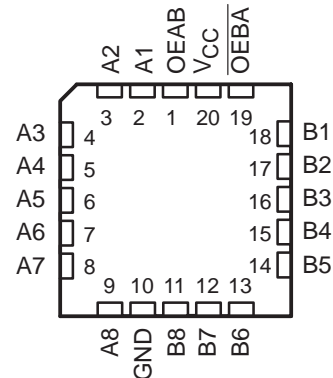
To ensure the high-impedance state during power up or power down,  $\overline{\text{OEBA}}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver. OEAB should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

The SN54ABT620 is characterized for operation over the full military temperature range of  $-55^\circ\text{C}$  to  $125^\circ\text{C}$ . The SN74ABT620 is characterized for operation from  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

SN54ABT620 . . . J PACKAGE  
SN74ABT620 . . . DB, DW, N, OR PW PACKAGE  
(TOP VIEW)



SN54ABT620 . . . FK PACKAGE  
(TOP VIEW)



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 **TEXAS  
INSTRUMENTS**

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# SN54ABT620, SN74ABT620 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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## recommended operating conditions (see Note 3)

|                 |                                    | SN54ABT620      |                 | SN74ABT620 |                 | UNIT |
|-----------------|------------------------------------|-----------------|-----------------|------------|-----------------|------|
|                 |                                    | MIN             | MAX             | MIN        | MAX             |      |
| V <sub>CC</sub> | Supply voltage                     | 4.5             | 5.5             | 4.5        | 5.5             | V    |
| V <sub>IH</sub> | High-level input voltage           | 2               |                 | 2          |                 | V    |
| V <sub>IL</sub> | Low-level input voltage            |                 | 0.8             |            | 0.8             | V    |
| V <sub>I</sub>  | Input voltage                      | 0               | V <sub>CC</sub> | 0          | V <sub>CC</sub> | V    |
| I <sub>OH</sub> | High-level output current          |                 | -24             |            | -32             | mA   |
| I <sub>OL</sub> | Low-level output current           |                 | 48              |            | 64              | mA   |
| Δt/Δv           | Input transition rise or fall rate | Outputs enabled |                 | 5          | 5               | ns/V |
| T <sub>A</sub>  | Operating free-air temperature     | -55             | 125             | -40        | 85              | °C   |

NOTE 3: All unused pins (control or I/O) of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                | TEST CONDITIONS   |  | T <sub>A</sub> = 25°C   |      |      | SN54ABT620 |      | SN74ABT620 |      | UNIT |    |    |
|--------------------------|---|--|-------------------------|------|------|------------|------|------------|------|------|----|----|
|                          |   |  | MIN                     | TYP† | MAX  | MIN        | MAX  | MIN        | MAX  |      |    |    |
| V <sub>IK</sub>          | V <sub>CC</sub> = 4.5 V, I <sub>I</sub> = -18 mA              |  | -1.2                    |      |      | -1.2       |      | -1.2       |      | V    |    |    |
| V <sub>OH</sub>          | V <sub>CC</sub> = 4.5 V, I <sub>OH</sub> = -3 mA              |  | 2.5                     |      |      | 2.5        |      | 2.5        |      | V    |    |    |
|                          | V <sub>CC</sub> = 5 V, I <sub>OH</sub> = -3 mA                |  | 3                       |      |      | 3          |      | 3          |      |      |    |    |
|                          | V <sub>CC</sub> = 4.5 V                                       | I <sub>OH</sub> = -24 mA   | 2                       |      |      | 2          |      |            |      |      |    |    |
| I <sub>OH</sub> = -32 mA |   | 2*   |                         |      |      |            | 2    |            |      |      |    |    |
| V <sub>OL</sub>          | V <sub>CC</sub> = 4.5 V                                       |  | I <sub>OL</sub> = 48 mA |      |      | 0.55       |      |            |      | V    |    |    |
|                          |   |  | I <sub>OL</sub> = 64 mA |      |      | 0.55*      |      |            | 0.55 |      |    |    |
| V <sub>hys</sub>         |   |  | 100                     |      |      |            |      |            |      | mV   |    |    |
| I <sub>I</sub>           | Control inputs  | V <sub>CC</sub> = 5.5 V, V <sub>I</sub> = V <sub>CC</sub> or GND                     | ±1                      |      |      | ±1         |      | ±1         |      | µA   |    |    |
|                          | A or B ports  |  | ±100                    |      |      | ±100       |      | ±100       |      |      |    |    |
| I <sub>OZH</sub> ‡       | V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.7 V               |  | 50                      |      |      | 50         |      | 50         |      | µA   |    |    |
| I <sub>OZL</sub> ‡       | V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 0.5 V               |  | -50                     |      |      | -50        |      | -50        |      | µA   |    |    |
| I <sub>off</sub>         | V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> ≤ 4.5 V |  | ±100                    |      |      |            |      | ±100       |      | µA   |    |    |
| I <sub>CEX</sub>         | V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V               |  | Outputs high            |      |      | 50         |      | 50         |      | µA   |    |    |
| I <sub>O</sub> §         | V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.5 V               |  | -50                     | -100 | -180 | -50        | -180 | -50        | -180 | mA   |    |    |
| I <sub>CC</sub>          | A or B ports  | V <sub>CC</sub> = 5.5 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND | Outputs high            |      |      | 5          |      | 250        |      | 250  |    | µA |
|                          |   |  | Outputs low             |      |      | 24         |      | 30         |      | 30   |    | mA |
|                          |   |  | Outputs disabled        |      |      | 0.5        |      | 250        |      | 250  |    | µA |
| ΔI <sub>CC</sub> ¶       | Data inputs   | V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND  | Outputs enabled         |      |      | 1.5        |      | 1.5        |      | 1.5  |    | mA |
|                          |   |  | Outputs disabled        |      |      | 0.05       |      | 0.05       |      | 0.05 |    |    |
|                          | Control inputs  | V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND  |                         | 1.5  |      |            | 1.5  |            | 1.5  |      |    |    |
| C <sub>i</sub>           | Control inputs  | V <sub>I</sub> = 2.5 V or 0.5 V  |                         | 4    |      |            |      |            |      |      | pF |    |
| C <sub>io</sub>          | A or B ports  | V <sub>O</sub> = 2.5 V or 0.5 V  |                         | 7    |      |            |      |            |      |      | pF |    |

\* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at V<sub>CC</sub> = 5 V.

‡ The parameters I<sub>OZH</sub> and I<sub>OZL</sub> include the input leakage current.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

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**OCTAL BUS TRANSCEIVERS**  
**WITH 3-STATE OUTPUTS**

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM<br>(INPUT)   | TO<br>(OUTPUT) | $V_{CC} = 5$ V,<br>$T_A = 25^\circ$ C |     | SN54ABT620 |     | SN74ABT620 |     | UNIT |
|-----------|-------------------|----------------|---------------------------------------|-----|------------|-----|------------|-----|------|
|           |                   |                | MIN                                   | MAX | MIN        | MAX | MIN        | MAX |      |
| $t_{PLH}$ | A or B            | B or A         | 1                                     | 4.1 | 1          |     | 1          | 4.8 | ns   |
| $t_{PHL}$ |                   |                | 1                                     | 4.3 | 1          |     | 1          | 4.8 |      |
| $t_{PZH}$ | $\overline{OEBA}$ | A              | 1.3                                   | 4.6 | 1.3        |     | 1.3        | 5.5 | ns   |
| $t_{PZL}$ |                   |                | 1                                     | 6.1 | 1          |     | 1          | 7.1 |      |
| $t_{PHZ}$ | $\overline{OEBA}$ | A              | 2                                     | 6.3 | 2          |     | 2          | 7   | ns   |
| $t_{PLZ}$ |                   |                | 1.4                                   | 5.4 | 1.4        |     | 1.4        | 5.8 |      |
| $t_{PZH}$ | OEAB              | B              | 1.6                                   | 6.2 | 1.6        |     | 1.6        | 6.8 | ns   |
| $t_{PZL}$ |                   |                | 2                                     | 5.9 | 2          |     | 2          | 6.4 |      |
| $t_{PHZ}$ | OEAB              | B              | 1.2                                   | 5.6 | 1.2        |     | 1.2        | 6.5 | ns   |
| $t_{PLZ}$ |                   |                | 1.1                                   | 4.7 | 1.1        |     | 1.1        | 5.6 |      |

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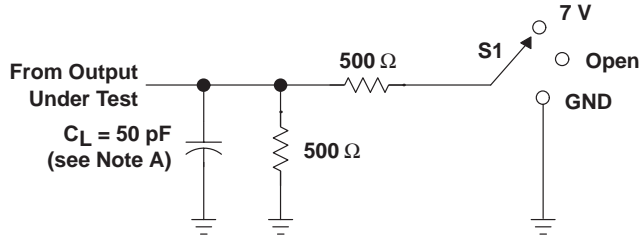


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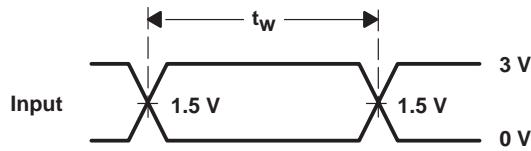
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**PARAMETER MEASUREMENT INFORMATION**

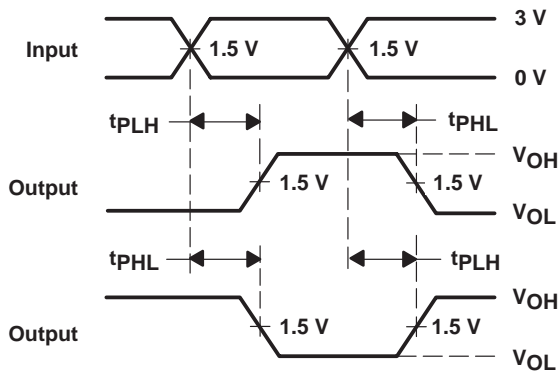


**LOAD CIRCUIT**

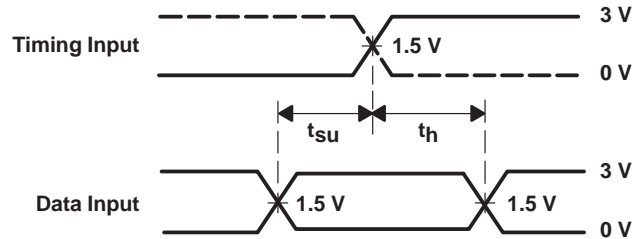
| TEST              | S1   |
|-------------------|------|
| $t_{PLH}/t_{PHL}$ | Open |
| $t_{PLZ}/t_{PZL}$ | 7 V  |
| $t_{PHZ}/t_{PZH}$ | Open |



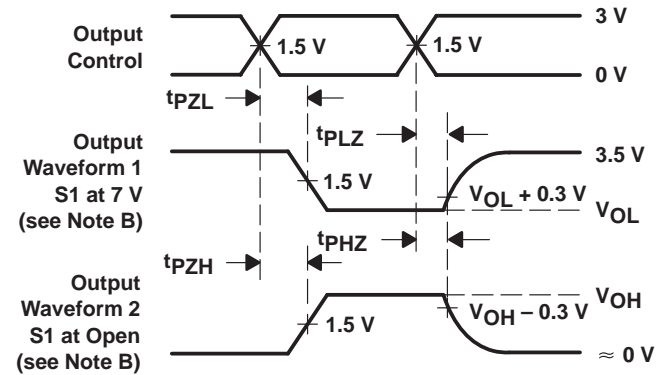
**VOLTAGE WAVEFORMS**  
**PULSE DURATION**



**VOLTAGE WAVEFORMS**  
**PROPAGATION DELAY TIMES**  
**INVERTING AND NONINVERTING OUTPUTS**



**VOLTAGE WAVEFORMS**  
**SETUP AND HOLD TIMES**



**VOLTAGE WAVEFORMS**  
**ENABLE AND DISABLE TIMES**  
**LOW- AND HIGH-LEVEL ENABLING**

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .  
 D. The outputs are measured one at a time with one transition per measurement.

**Figure 1. Load Circuit and Voltage Waveforms**

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/<br>Ball Finish | MSL Peak Temp <sup>(3)</sup> | Samples<br>(Requires Login) |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|----------------------|------------------------------|-----------------------------|
| SN74ABT620DBLE   | OBSOLETE              | SSOP         | DB              | 20   |             | TBD                     | Call TI              | Call TI                      |                             |
| SN74ABT620DW     | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| SN74ABT620DWE4   | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| SN74ABT620DWG4   | ACTIVE                | SOIC         | DW              | 20   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| SN74ABT620DWR    | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| SN74ABT620DWRE4  | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| SN74ABT620DWRG4  | ACTIVE                | SOIC         | DW              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| SN74ABT620N      | ACTIVE                | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU            | N / A for Pkg Type           |                             |
| SN74ABT620NE4    | ACTIVE                | PDIP         | N               | 20   | 20          | Pb-Free (RoHS)          | CU NIPDAU            | N / A for Pkg Type           |                             |
| SN74ABT620NSR    | ACTIVE                | SO           | NS              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| SN74ABT620NSRE4  | ACTIVE                | SO           | NS              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| SN74ABT620NSRG4  | ACTIVE                | SO           | NS              | 20   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

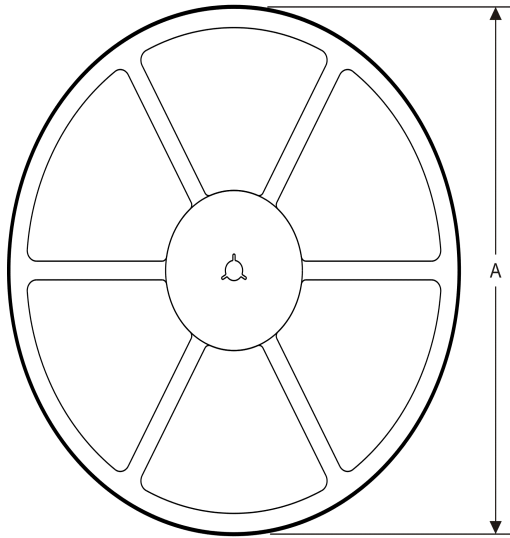
<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**TAPE AND REEL INFORMATION**

**REEL DIMENSIONS**



**TAPE DIMENSIONS**

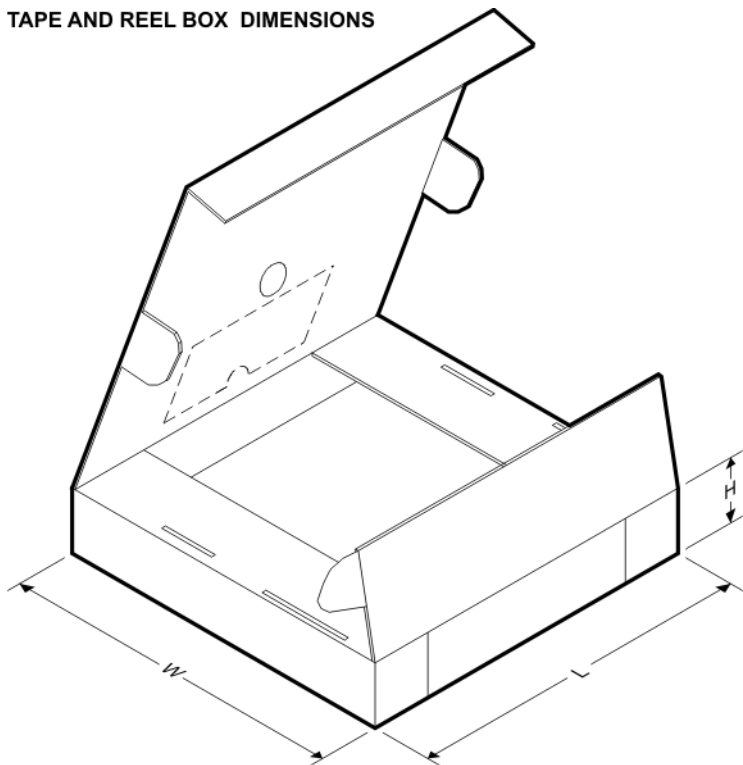


|    |   |
|----|---|
| A0 | Dimension designed to accommodate the component width     |
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

**TAPE AND REEL INFORMATION**

\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74ABT620DWR | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.0    | 2.7     | 12.0    | 24.0   | Q1            |
| SN74ABT620NSR | SO           | NS              | 20   | 2000 | 330.0              | 24.4               | 8.2     | 13.0    | 2.5     | 12.0    | 24.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ABT620DWR | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74ABT620NSR | SO           | NS              | 20   | 2000 | 367.0       | 367.0      | 45.0        |

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|                        |  |
|------------------------|--|
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| Amplifiers             | <a href="http://amplifier.ti.com">amplifier.ti.com</a>                               |
| Data Converters        | <a href="http://dataconverter.ti.com">dataconverter.ti.com</a>                       |
| DLP® Products          | <a href="http://www.dlp.com">www.dlp.com</a>   |
| DSP                    | <a href="http://dsp.ti.com">dsp.ti.com</a>   |
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| Power Mgmt             | <a href="http://power.ti.com">power.ti.com</a>                                       |
| Microcontrollers       | <a href="http://microcontroller.ti.com">microcontroller.ti.com</a>                   |
| RFID                   | <a href="http://www.ti-rfid.com">www.ti-rfid.com</a>                                 |
| OMAP Mobile Processors | <a href="http://www.ti.com/omap">www.ti.com/omap</a>                                 |
| Wireless Connectivity  | <a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a> |

### Applications

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